

Electronic Patent Application Fee Transmittal

Application Number:	10762318			
Filing Date:	23-Jan-2004			
Title of Invention:	METHOD FOR LOW TEMPERATURE BONDING AND BONDED STRUCTURE			
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Filer:	Marvin Jay Spivak/Sachie Fazzone			
Attorney Docket Number:	247830US-20 CONT			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Claims in excess of 20	1202	6	50	300
Independent claims in excess of 3	1201	1	200	200
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				500